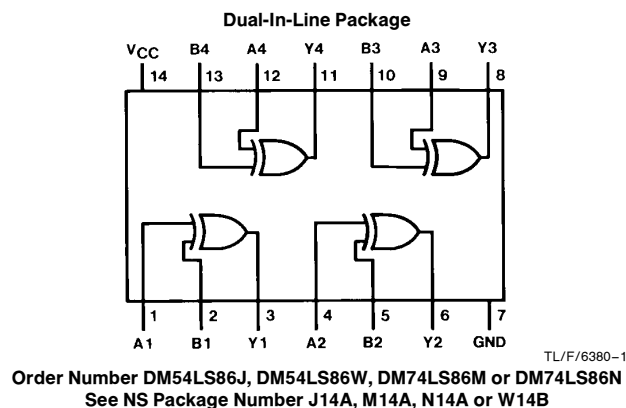


DM54LS86/DM74LS86 Quad 2-Input Exclusive-OR Gates

General Description

This device contains four independent gates each of which performs the logic exclusive-OR function.

Connection Diagram



Function Table

$$Y = A \oplus B = \bar{A}B + A\bar{B}$$

Inputs		Output
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	L

H = High Logic Level

L = Low Logic Level

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	
DM54LS	−55°C to +125°C
DM74LS	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	DM54LS86			DM74LS86			Units
		Min	Nom	Max	Min	Nom	Max	
V _{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High Level Input Voltage	2			2			V
V _{IL}	Low Level Input Voltage			0.7			0.8	V
I _{OH}	High Level Output Current			−0.4			−0.4	mA
I _{OL}	Low Level Output Current			4			8	mA
T _A	Free Air Operating Temperature	−55		125	0		70	°C

Electrical Characteristics over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 1)	Max	Units
V _I	Input Clamp Voltage	V _{CC} = Min, I _I = −18 mA			−1.5	V
V _{OH}	High Level Output Voltage	V _{CC} = Min, I _{OH} = Max, V _{IL} = Max, V _{IH} = Min	DM54 2.5	3.4		V
			DM74 2.7	3.4		
V _{OL}	Low Level Output Voltage	V _{CC} = Min, I _{OL} = Max, V _{IL} = Max, V _{IH} = Min	DM54	0.25	0.4	V
			DM74	0.35	0.5	
		I _{OL} = 4 mA, V _{CC} = Min	DM74	0.25	0.4	
I _I	Input Current @ Max Input Voltage	V _{CC} = Max, V _I = 7V			0.2	mA
I _{IH}	High Level Input Current	V _{CC} = Max, V _I = 2.7V			40	μA
I _{IL}	Low Level Input Current	V _{CC} = Max, V _I = 0.4V			−0.6	mA
I _{OS}	Short Circuit Output Current	V _{CC} = Max (Note 2)	DM54 −20		−100	mA
			DM74 −20		−100	
I _{CCH}	Supply Current with Outputs High	V _{CC} = Max (Note 3)		6.1	10	mA
I _{CCL}	Supply Current with Outputs Low	V _{CC} = Max (Note 4)		9	15	mA

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 2: Not more than one output should be shorted at a time, and the duration should not exceed one second.

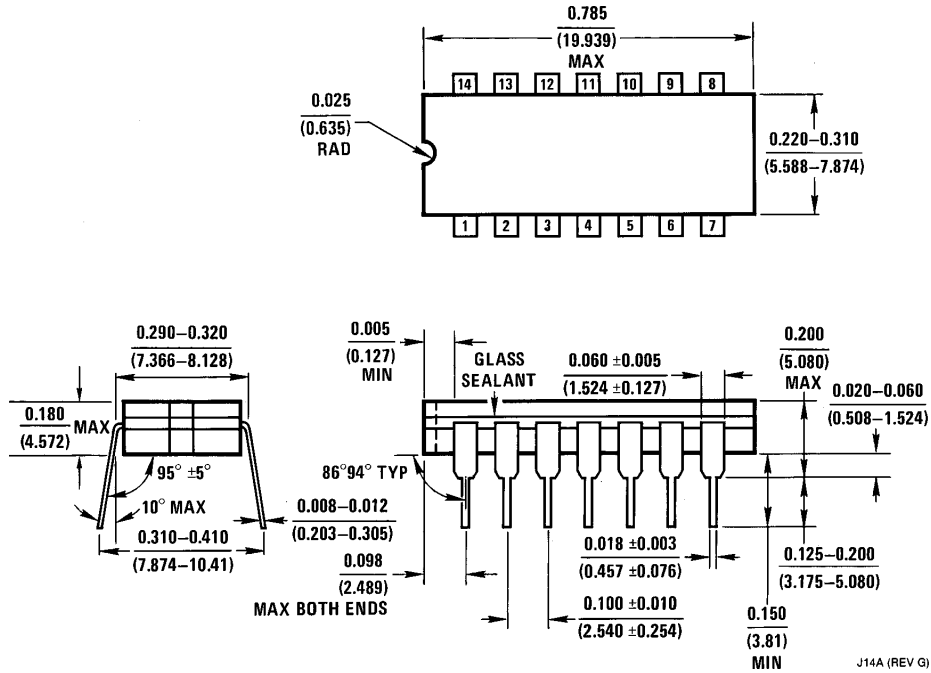
Note 3: I_{CCH} is measured with all outputs open, one input at each gate at 4.5V, and the other inputs grounded.

Note 4: I_{CCL} is measured with all outputs open and all inputs grounded.

Switching Characteristics at $V_{CC} = 5V$ and $T_A = 25^\circ C$ (See Section 1 for Test Waveforms and Output Load)

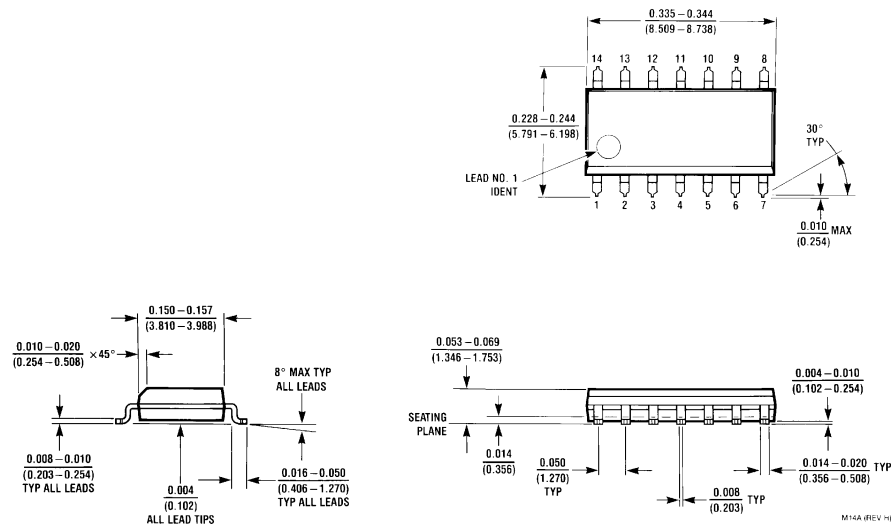
Symbol	Parameter	Conditions	R _L = 2 kΩ				Units
			C _L = 15 pF		C _L = 50 pF		
			Min	Max	Min	Max	
t _{PLH}	Propagation Delay Time Low to High Level Output	Other Input Low		18		23	ns
t _{PHL}	Propagation Delay Time High to Low Level Output			17		21	ns
t _{PLH}	Propagation Delay Time Low to High Level Output	Other Input High		10		15	ns
t _{PHL}	Propagation Delay Time High to Low Level Output			12		15	ns

Physical Dimensions inches (millimeters)

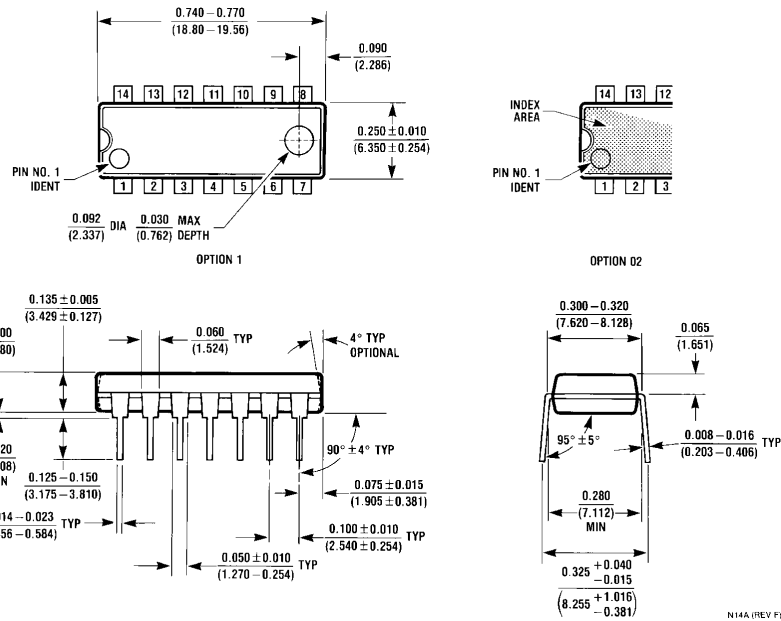


14-Lead Ceramic Dual-In-Line Package (J)
Order Number DM54LS86J
NS Package Number J14A

Physical Dimensions inches (millimeters) (Continued)

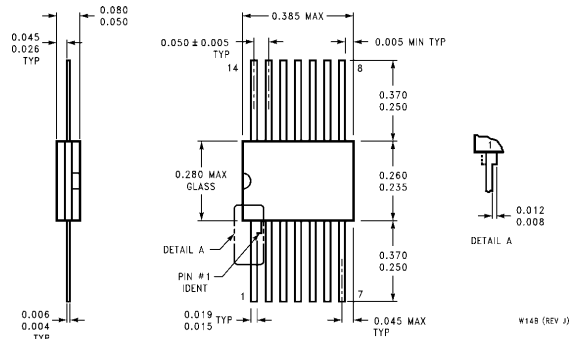


14-Lead Small Outline Molded Package (M)
Order Number DM74LS86M
NS Package Number M14A



14-Lead Molded Dual-In-Line Package (N)
Order Number DM74LS86N
NS Package Number N14A

Physical Dimensions inches (millimeters) (Continued)



14-Lead Ceramic Flat Package (W)
Order Number DM74LS86W
NS Package Number W14B

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